



Product Change Notification

Change Notification #: 114603 - 00

Change Title: Intel® SSD DC P3500 Series (250GB, 500GB, 2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 1/2 Height PCIe 3.0 x4, 20nm, MLC) Generic Single Pack, Intel® SSD DC P3500 Series (250GB, 500GB, 1/2 Height PCIe 3.0, 20nm, MLC) Generic Single Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 1/2 Height PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack, PCN 114603-00, Manufacturing Site, Label, Addition of Manufacturing Site, Label Update

Date of Publication: May 18, 2016

Key Characteristics of the Change:

Manufacturing Site, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 17, 2016
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Description of Change to the Customer:

Intel is adding an additional manufacturing site to manufacture the Intel® SSD DC P3500 Series.

The new manufacturing site will be using the identical manufacturing process as the existing manufacturing sites. There will be some aesthetic changes to the labels as described below:

1. ISN or SN number: PHXXXXXXXXXXXXXXXXXX. PH is the vendor code of PTI
2. Carton number: PHXXXXXXXX. PH is the vendor code of PTI
3. Batch number: TWPHXXXXXX. TW stands for Taiwan, PH is the vendor code of PTI
4. Manufactory country or region:
 - Designed in USA, assembled in Taiwan, or Made in Taiwan
 - MADE IN TAIWAN WITH PARTIAL FOREIGN CONTENT
 - (China is replaced by Taiwan)

SFF Label:

INTEL® SSD DC PXXXX SERIES XXXGB

PCI EXPRESS®

nvm EXPRESS

VDC AMPS
+3.3V 1mA
+12V 2.45A

FW: XXXXXXXX

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA WO: XXXXXXXX

SA: XXXXXX-XXX
PBA: XXXXXX-XXX
LBA XXX,XXX,XXX
Pb-free 2LI
CAN ICES-3(A)/NMB-3(A)
Model: SSDXXXXXXXXXX
2.5" NMEe/PCIe SSD XXXG

WWN: XXXXXXXXXXXXXXXX

Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in Taiwan.

D33025 VCI KC MSIPREMI-CPU-SSDPC2 20

CE

US E139761

MOQ 1 Pizza label:

SSDXXXXXXXXXXXX

QTY:1 Pb-free 2LI

MM #: XXXXXX

VERSION #: XXXXXX-XXX

MADE IN TAIWAN WITH PARTIAL FOREIGN CONTENT

CARTON #: PHXXXXXXXX

BATCH #: TWPHXXXXXX

SN: PHXXXXXXXXXXXXXXX

PACK DATE: XX XXX XX

PACKED BY: XXXXXXX

7 35858 27818 8

MOQ 10 Pizza label:

SSDXXXXXXXXXXXX

QTY:1 Pb-free 2LI

MM #: XXXXXX

VERSION #: XXXXXX-XXX

MADE IN TAIWAN WITH PARTIAL FOREIGN CONTENT

BATCH #: TWPHXXXXXX

SN: PHXXXXXXXXXXXXXXX

PACK DATE: XX XXX XX

PACKED BY: XXXXXXX

7 35858 27818 8

MOQ 10 Disti label:

SSDSC2BBXXG4
VERSION #: XXXXX-XXX
MADE IN TAIWAN WITH
PARTIAL FOREIGN CONTENT
CARTON #: PHXXXXXXXX

MM #: XXXXXX
PACK DATE: XX XXX XX
PACKED BY: XXXXXX
BATCH #: TWPHXXXXXX

QTY:10
Pb-free
2LI

7 35858 12345 7

AIC GEN Product labels:

Intel® SSD DC PXXXX Series
Model: SSDXXXXXXXXX
PBA: XXXXX-XXX LBA XXX,XXX,XXX

ISN: PHXXXXXXXXXXXXXXXXX
SA: XXXXX-XXX

FW: XXXXXXXX Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN
CAN ICES-3(A)/NMB-3(A) WO: XXXXXXXXXXXX
Designed in USA, assembled in Taiwan. WWN: XXXXXXXXXXXXXXXXX

www.intel.com

Pizza label MOQ 1:

SSDXXXXXXXXXXXX
VERSION #: XXXXX-XXX
MADE IN TAIWAN WITH
PARTIAL FOREIGN CONTENT
CARTON #: PHXXXXXXXX
SN: PHXXXXXXXXXXXXXXXXX

MM #: XXXXXX
PACK DATE: XX XXX XX
PACKED BY: XXXXXX
BATCH #: TWPHXXXXXX

QTY:1
Pb-free
2LI

7 35858 27818 8

Disti label MOQ 10:

SSDSC2BBXXG4
VERSION #: XXXXX-XXX
MADE IN TAIWAN WITH
PARTIAL FOREIGN CONTENT
CARTON #: PHXXXXXXXX

MM #: XXXXXX
PACK DATE: XX XXX XX
PACKED BY: XXXXXX
BATCH #: TWPHXXXXXX

QTY:10
Pb-free
2LI

7 35858 12345 7

Customer Impact of Change and Recommended Action:

The place of manufacturing has no impact to customer products. No customer action is required.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDPEDMX250G4ES	928982
SSDPEDMX500G4ES	928983
SSDPE2MX250G4ES	928992
SSDPE2MX500G4ES	928993
SSDPE2MX020T401	933086
SSDPEDMX020T401	933095
SSDPE2MX400G401	937519
SSDPE2MX012T401	937521
SSDPEDMX400G401	937525
SSDPEDMX012T401	937527
SSDPE2MX400G410	939931
SSDPE2MX012T410	939932
SSDPE2MX020T410	939933
SSDPEDMX400G410	939934
SSDPEDMX012T410	939935
SSDPEDMX020T410	939936

PCN Revision History:

Date of Revision:

May 18, 2016

Revision Number:

00

Reason:

Originally Published PCN



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114603 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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